

09/787139

JG08 Rec'd PCT/PTO

14 MAR 2001

PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Honchin EN et al.

Appln. No. Based on  
PCT/JP99/05003

Group Art Unit: Unassigned

Confirmation No.: Unknown

Examiner: Unassigned

Filed: March 14, 2001

For: PRINTED WIRING BOARD AND  
ITS MANUFACTURING METHOD

March 14, 2001

PRELIMINARY AMENDMENT

Commissioner for Patents  
Washington, D.C. 20231

Sir:

Prior to examination, please amend the above-identified application as follows:

IN THE CLAIMS:

Please enter the following amended claims:

17. The electroless plating solution according to Claim 14, the temperature of which is 25 to 40°C.

18. The electroless plating solution according to Claim 14 wherein the copper deposition rate of said electroless plating solution is 1 to 2  $\mu\text{m}/\text{hour}$ .